

Making Every Connection Better

Precise Clock for Seamless Synchronization & Ultimate Data Transmission

ThermSym[™] OCXO **Product Brief**

Think of Frequency Think of TXC



Bridge Smarter Connectivity for Advanced Networks

https://www.txccorp.com



ThermSym OCXO

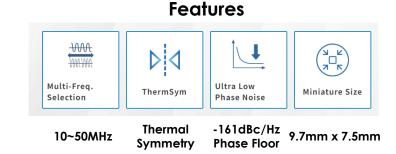
ThermSym[™] OCXO Family



OE Series 14mm x 9mm



OG Series 9mm x 7mm



Empowering 5G Synchronization

Introduction

TXC has used its extensive package design experience to develop a novel patented OCXO technology. The industry first SC-cut crystal IC OCXO in a small form package using TXC's patented ThermSym (Thermal Symmetry) technology with a heater-embedded ceramic package provides excellent thermal performance compared to conventional IC OCXO oven structure (Thermal Asymmetry). The SC-cut crystal of the ThermSym OCXO with better quality factor further enhances the phase noise, short-term stability, aging performance, etc.



ThermSym OCXO Empowering 5G Synchronization

TXC ThermSym[™]Technology (::) (**C**) 95 Symmetric thermal field Thermal Symmetry Better Oven Stability + Better Reliability Crystal~94.6 C 94 Crystal blank in the ceramic package 93 Embedded Heater~95 °C Cover 92 IC is attached on the bottom **IC~94.8**℃ 91 of the ceramic package Heater embedded in the ceramic package 90 A sectional view 🙁 Conventional IC OCXO Structure Asymmetric thermal field **(C)** 95 Crystal~91.2 °C 94 **Embedded Heater** 93 PCB substrate 92 IC~95°C 91 Protected by US patents 90 Heat source from power transistor on IC

Applications & Compliance Support

- Small Cell
- RRU/AAU
- PTP enable Switch/Router
- Smart power grid synchronization
- Packet Based Telecom Time Slave Clock on G.8273.2
- SyncE Ethernet Equipment Clocks based on G.8262
- Enhanced Ethernet Equipment Clocks based on G.8262.1
- Telecom Transparent Clocks based on G.8273.3

Benefits

Feature	Benefits
ThermSym Technology Thermal Symmetry patented technology	 Thermal Symmetry patented technology with a heater-embedded ceramic package provides excellent thermal performance. Better reliability compared to the solution that uses the embedded heater in the IC.
Integrated Circuit Technology Advanced oven control algorism	IC based, superior reliability compared to traditional discrete OCXO
Excellent frequency stability <±20ppb over -40 to 95°C	 Fully compliant with RRU, small cell, optical module and microwave transmission system applications.
High-Q SC-Cut Crystal Unit Innovative in-house developed initiatives and solutions <161 dBc/Hz at phase floor	 Higher Q-factor and better short-term and long-term stability compared to AT-cut crystal and MEMS resonator Resilient to airflow interference Enable RRU PLLs to use a single mode to meet both wander and jitter performance for network synchronization and air interface requirements